

600V, 40A, Trench FS II Fast IGBT

General Description

Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FS II IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE (sat)}
- High speed switching
- Positive temperature coefficient in V_{CE (sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives

Package Marking and Ordering Information

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Device	Device Package	Device Marking							
NCE40TH60BT	TO-247	NCE40TH60BT							



Schematic diagram

G

TO-247

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
VCES	Collector-Emitter Voltage	600	V
V _{GES}	Gate- Emitter Voltage	±30	V
	Collector Current	80	A
lc	Collector Current @Tc = 100 °C	40	A
I _{Cpuls}	Pulsed Collector Current, t _p limited by T _{jmax}	120	A
-	turn off safe operating area, V_{CE} =600V, T _j =175°C	120	A
I _F	Diode Continuous Forward Current @T _c = 100 °C	30	A
I _{FM}	Diode Maximum Forward Current	90	А
_	Power Dissipation @ $T_c = 25^{\circ}C$	288	W
PD	Power Dissipation @T _c = 100 °C	144	W
T _J ,T _{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C
T∟	Maximum Temperature for Soldering	260	°C
t _{sc}	Short circuit withstand time V_{GE} =15V, V_{CC} 400V, Allowed number of short circuits<1000Time between short circuits: \geq 1.0s, T_j \leq 150°C	5	us



NCE40TH60BT

Thermal Characteristic

Symbol	Parameter	Value	Units
R _{θJC}	Thermal Resistance, Junction to case for IGBT	0.52	°C/W
R _{θJC}	Thermal Resistance, Junction to case for Diode	2.12	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

Cume he al	Deversator	Test Conditions		Value			11
Symbol	Parameter	Test Co	naitions	Min.	Тур.	Max.	Units
STATIC Cha	racteristics				•		
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V,I _{CE} =1mA		600			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V,	V _{CE} =600V			40	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} =-30 ^v	V,V _{CE} =0V			200	nA
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =40A	T _j =25°C		1.7	1.9	V
()		V _{GE} =15V	T _j =175°C		1.9		V
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	Ic=1mA,Vce=Vge		4.0	5.0	6.0	V
Dynamic Cha	aracteristics						
Cies	Input Capacitance	V _{CE} =25V,V _{GE} =0V, f=1MHz			4894		pF
Coes	Output Capacitance				136		
Cres	Reverse Transfer Capacitance	1-1			94		
Qg	Total Gate Charge				176		
Q _{ge}	Gate to Emitter Charge				38		nC
Q _{gc}	Gate to Collector Charge	V _{cc} =480V, I _c =40A V _{GE} =15V			73		
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: \geq 1.0s		V _{CC} ≪400V, T _j ≪150°C		240		А
Switching Cl	haracteristics						
$t_{d(ON)}$	Turn-on Delay Time				19		
tr	Rise Time				17		20
$t_{\text{d}(\text{OFF})}$	Turn-Off Delay Time	Vcc=400)V,I _C =40A		168		ns
t _f	Fall Time	V _{GE} =0/15	5V, R _g =5Ω		16		
Eon	Turn-On Switching Loss	Inducti	ve Load		0.58		
E _{off}	Turn-Off Switching Loss				0.48		mJ
E _{ts}	Total Switching Loss				1.06		

Electrical Characteristics of the Diode (T_c = 25°C unless otherwise specified)

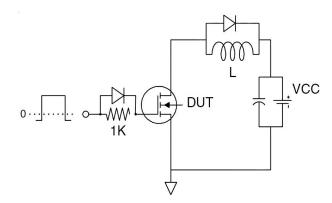
Symphol	Parameter	Toot Conditions	Rating			Unite	
Symbol		Test Conditions	Min.	Тур.	Max.	Units	
Vfm	Diode Forward Voltage	I⊧=30A		1.75	2.40	V	
Trr	Reverse Recovery Time	l⊧=30A di/dt=200A/us		170		ns	
IRRM	Diode Peak Reverse Recovery Current			6.5		А	
Qrr	Reverse Recovery Charge			0.6		uC	
Pulse width t _t s≤380μs,δ≤2%							





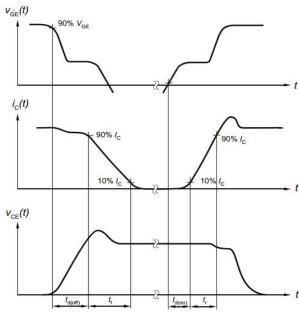
Test Circuit

1) Gate Charge Test Circuit

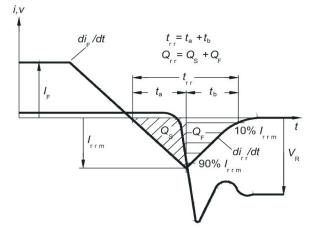


Switching characteristics

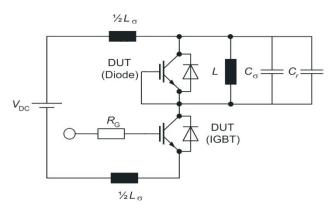
1) Definition of switching times



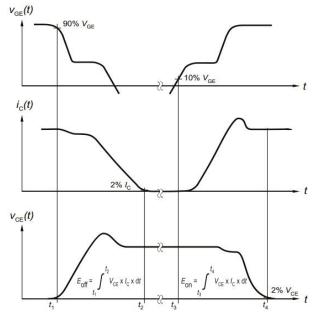
3) Definition of diode switching characteristics



2) Switch Time Test Circuit



2) Definition of switching losses





Typical Electrical and Thermal Characteristics

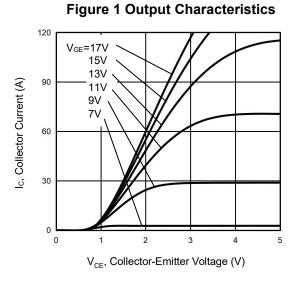


Figure 3 V_{CEsat} vs. Case Temperature

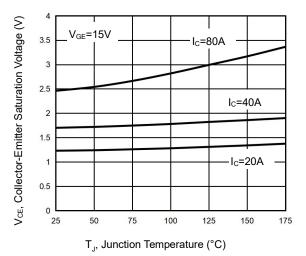
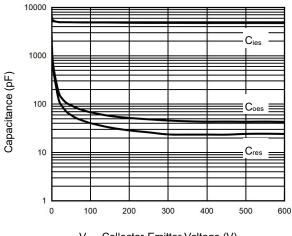


Figure 5 Capacitance Characteristics



V_{CE}, Collector-Emitter Voltage (V)

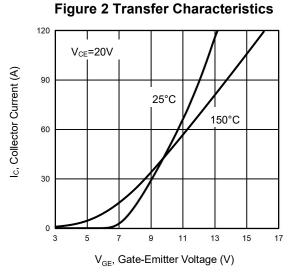


Figure 4 Saturation Voltage vs. VGE

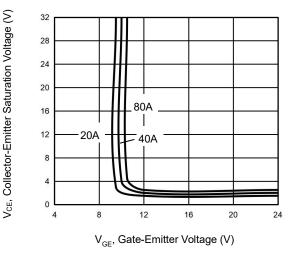
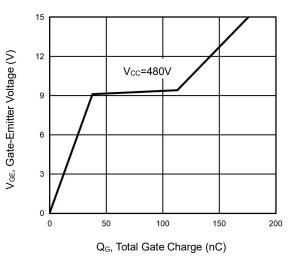


Figure 6 Gate charge waveform





Typical Electrical and Thermal Characteristics

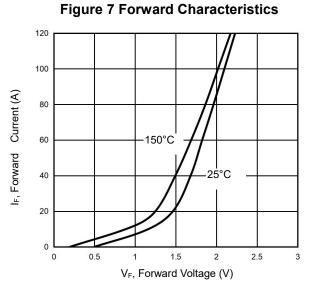


Figure 9 Typical Switching Times as a Function of Gate Resistor

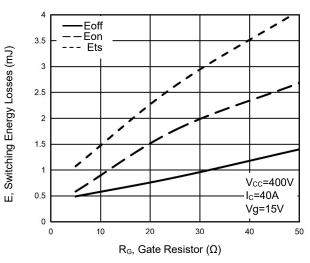


Figure 11 Gate-emitter Threshold Voltage as a Function of Junction Temperature

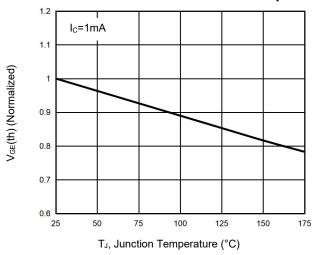


Figure 8 V_F vs. Temperature

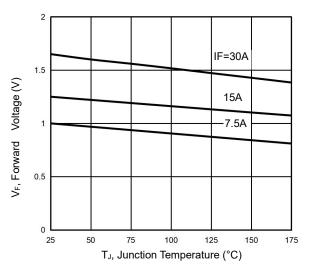
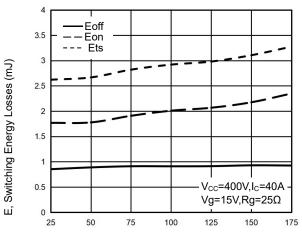
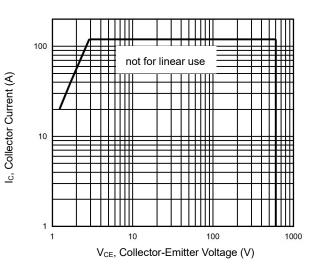


Figure 10 Typical Switching Times as a Function of Junction Temperature



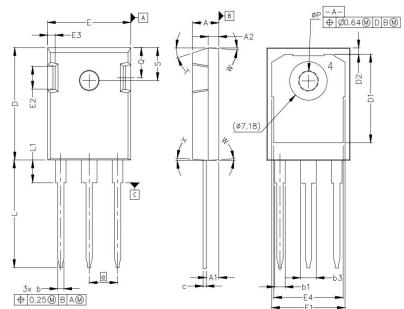
 $T_{\text{J}},$ Junction Temperature (°C)

Figure 12 Forward Bias Safe Operating Area





TO-247-B Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.83	5.21	0.19	0.21	
A1	2.29	2.54	0.09	0.10	
A2	1.91	2.16	0.08	0.09	
b	1.07	1.33	0.04	0.05	
b1	1.91	2.41	0.08	0.10	
b3	2.87	3.38	0.11	0.13	
С	0.55	0.68	0.02	0.03	
D	20.80	21.10	0.82	0.83	
D1	16.25	17.65	0.64	0.70	
D2	0.95	1.25	0.04	0.05	
E	15.75	16.13	0.62	0.64	
E1	13.10	14.15	0.52	0.56	
E2	3.68	5.10	0.15	0.20	
E3	1.00	1.90	0.04	0.08	
E4	12.38	13.43	0.49	0.53	
е	5.44	BSC	0.21	0.21 BSC	
L	19.81	20.32	0.78	0.80	
L1	4.10	4.40	0.16	0.17	
ØP	3.51	3.65	0.14	0.15	
Q	5.49	6.00	0.22	0.24	
S	6.04	6.30	0.24	0.25	
Т	17.5° REF				
W		3.5	° REF		
Х	4° REF				



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